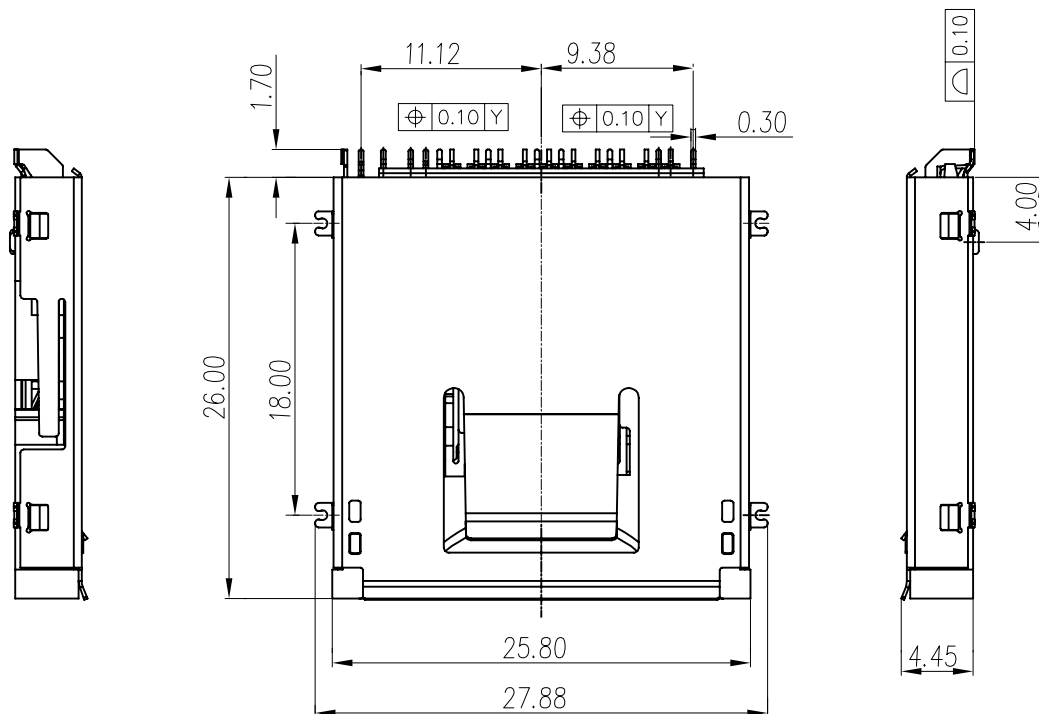


A
B
C
D
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F

12345678

REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD



Specification

1.MATERIAL:

HOUSING:HIGH TEMPERATURE THERMOPALSTIC

UL 94-0 . COLOR:BLACK

CONTACT: COPPER ALLOY

COVER: COPPER ALLOY

2.PLATING:



UNDERPLATE: NICKEL

CONTACT AREA: GOLD OVER NICKEL

SOLDER AREA: TIN PLATING OVER NICKEL(LEAD FREE).

3.COPLANARITY MUST BE WITHIN 0.10mm

ROHS Compliant

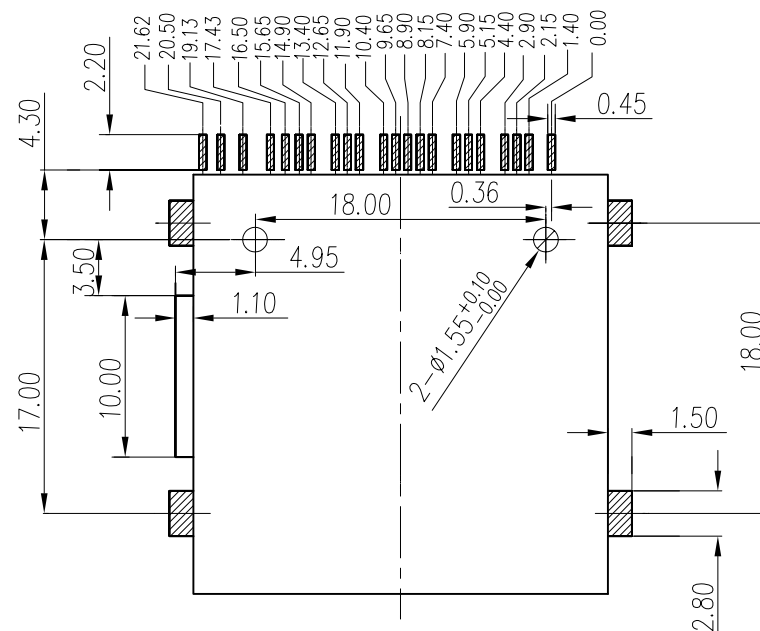
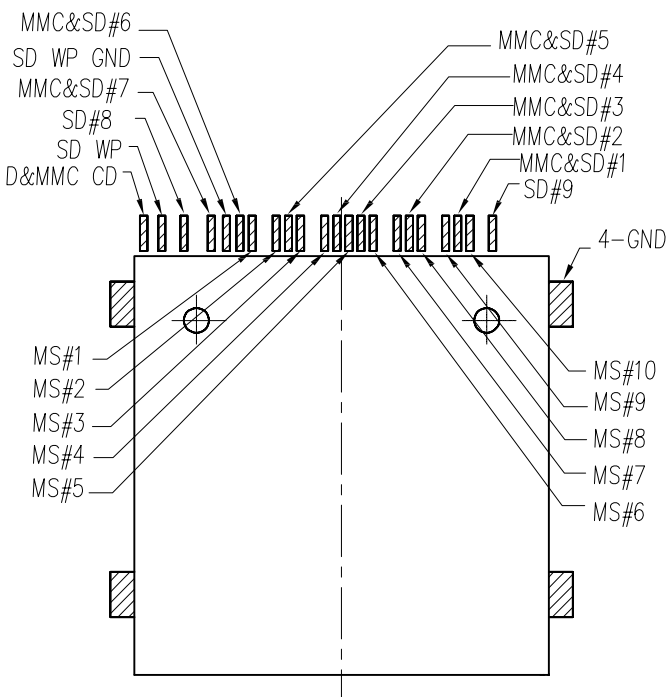
PART NO:		MATERIAL:			
MODEL NO:		FINSH:			
UNIT: mm	SIZE: A4	COLOR:		PART NAME: 3IN1 CARD CONN	
TOLERANCE UNSPECIFIED		DR: 陳杰 '11/10/26			
.x	±0.30	CHK: Kevin '11/10/26		DWG NO:	0D-S/A-633
.xx	±0.20	APP: Kent '11/10/26		SCALE:	1:1
.xxx	±0.10			SHEET:	1 of 2
ANG.	±1°			REV:	A0
					

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1 2 3 4 5 6 7 8

REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD





P.C.B LAYOUT
(TOLERANCE±0.05)

PIN ASSIGNMENT

PIN NO.	MEMORY CARD PIN NO.	PIN NO.	MEMORY CARD PIN NO.
MMC&SD#1	MMC/SD-1 (CD/DAT3)	MS#1	VSS
MMC&SD#2	MMC/SD-2 (CMD)	MS#2	BS
MMC&SD#3	MMC/SD-3 (Vss1)	MS#3	DATA1
MMC&SD#4	MMC/SD-4 (VDD)	MS#4	SDIO/DATA0
MMC&SD#5	MMC/SD-5 (CLK)	MS#5	DATA2
MMC&SD#6	MMC/SD-6 (Vss2)	MS#6	INS
MMC&SD#7	MMC/SD-7 (DAT0)	MS#7	DATA3
SD#8	SD-8 (DAT1)	MS#8	SCLK
SD#9	SD-9 (DAT2)	MS#9	VCC
		MS#10	VSS

ROHS Compliant

PART NO:		MATERIAL:			
MODEL NO:		FINSH:			
UNIT: mm	SIZE: A4	COLOR:		PART NAME:	
TOLERANCE UNSPECIFIED		DR: 陳杰 '11/10/26		3IN1 CARD CONN	
.x ±0.30		CHK: Kevin '11/10/26		DWG NO:	0D-S/A-633
.xx ±0.20		APP: Kent '11/10/26		SCALE:	1:1
.xxx ±0.10				SHEET:	2 of 2
ANG. ±1°				REV:	A0
					

1 2 3 4 5 6 7 8